# 1761327-2 ACTIVE

#### SFP28

TE Internal #: 1761327-2

SFP, SFP+ & zSFP+, Cage Assembly, Data Rate (Max) 16 Gb/s, Internal/External EMI Springs, SFP, Not Optional, 2 x 6, Through

Hole - Press-Fit, 6 Port

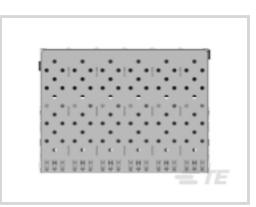
View on TE.com >

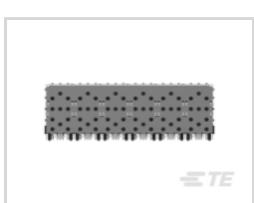


Connectors > Pluggable IO Connectors & Cages > SFP, SFP+ & zSFP+ > SFP+ Stacked Cage Assemblies











Pluggable I/O Product Type: Cage Assembly

Data Rate (Max): 16 Gb/s

EMI Containment Feature Type: Internal/External EMI Springs

Pluggable I/O Applications: **SFP**Lightpipe Options: **Not Optional** 

All SFP+ Stacked Cage Assemblies (122)

## **Features**

## **Product Type Features**

Form Factor	SFP
Cage Type	Ganged
Pluggable I/O Product Type	Cage Assembly
Lightpipe Options	Not Optional
Connector System	Cable-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Port Matrix Configuration	2 x 6
Number of Ports	6

40

### **Electrical Characteristics**

Number of Positions



Data Rate (Max)	16 Gb/s
Termination Features	
Termination Method to Printed Circuit Board	Through Hole - Press-Fit
Mechanical Attachment	
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	.8 mm[.03 in]
Usage Conditions	
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Pluggable I/O Applications	SFP
Circuit Application	Signal
Other	
EMI Containment Feature Type	Internal/External EMI Springs

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not applicable for solder process capability

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits



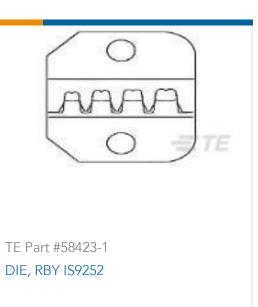
as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

## Customers Also Bought



MINI I/O PLUG KIT TYPE II L













TE Part #1888251-1 Low Profile, RJ45, 1x4, GRN/YEL









DT04-2P-TN82, REC, 2P, BLK, N, **SNAPXCAP** 



## **Documents**

## **Product Drawings**

2X6 CAGE AND PT CONNECTOR ASSY, STD PROF

English

#### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_1761327-2\_A.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_1761327-2\_A.3d\_igs.zip

English

SFP, SFP+ & zSFP+, Cage Assembly, Data Rate (Max) 16 Gb/s, Internal/External EMI Springs, SFP, Not Optional, 2 x 6, Through Hole - Press-Fit, 6 Port



Customer View Model ENG\_CVM\_CVM\_1761327-2\_A.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

**Product Specifications** 

**Application Specification** 

English